

January 1993 Revised November 1999

74ABT573

Octal D-Type Latch with 3-STATE Outputs

General Description

The ABT573 is an octal latch with buffered common Latch Enable (LE) and buffered common Output Enable (\overline{OE}) inputs.

This device is functionally identical to the ABT373 but has broadside pinouts.

Features

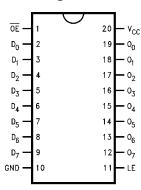
- Inputs and outputs on opposite sides of package allow easy interface with microprocessors
- Useful as input or output port for microprocessors
- Functionally identical to ABT373
- 3-STATE outputs for bus interfacing
- Output sink capability of 64 mA, source capability of 32 mA
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Output switching specified for both 50 pF and 250 pF loads
- Guaranteed simultaneous switching, noise level and dynamic threshold performance
- Guaranteed latchup protection
- High impedance glitch-free bus loading during entire power up and power down
- Nondestructive hot insertion capability

Ordering Code:

| Order Number | Package Number | Package Description |
|--------------|----------------|---|
| 74ABT573CSC | M20B | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body |
| 74ABT573CSJ | M20D | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| 74ABT573CMSA | MSA20 | 20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide |
| 74ABT573CMTC | MTC20 | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| 74ABT573CPC | N20A | 20-Lead Plastic Dual-In-Line (PDIP), JEDEC MS-01, 0.300" Wide |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Pin Descriptions

| Pin Names | Descriptions | | | | | |
|--------------------------------|--|--|--|--|--|--|
| D ₀ -D ₇ | Data Inputs | | | | | |
| LE | Latch Enable Input (Active HIGH) | | | | | |
| ŌĒ | 3-STATE Output Enable Input (Active LOW) | | | | | |
| O ₀ -O ₇ | 3-STATE Latch Outputs | | | | | |

Functional Description

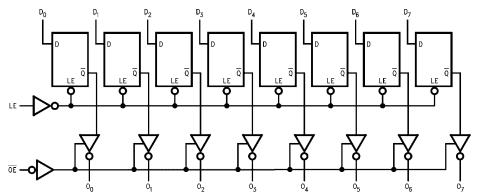
The ABT573 contains eight D-type latches with 3-STATE output buffers. When the Latch Enable (LE) input is HIGH, data on the $D_{\rm n}$ inputs enters the latches. In this condition data on the D_n inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-STATE buffers are controlled by the Output Enable (\overline{OE}) input. When \overline{OE} is LOW, the buffers are in the bi-state mode. When \overline{OE} is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches. new data into the latches.

Function Table

| | Outputs | | |
|----|---------|---|----------------|
| OE | LE | D | 0 |
| L | Н | Н | Н |
| L | Н | L | L |
| L | L | Χ | O ₀ |
| Н | Χ | Χ | Z |

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

 $O_0 = \mbox{\sc Value}$ stored from previous clock cycle

Absolute Maximum Ratings(Note 1)

 $\begin{array}{lll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{V}_{CC} \mbox{Pin Potential to Ground Pin} & -0.5\mbox{V to } +7.0\mbox{V} \\ \end{array}$

 $\begin{array}{lll} \mbox{Input Voltage (Note 2)} & -0.5\mbox{V to } +7.0\mbox{V} \\ \mbox{Input Current (Note 2)} & -30\mbox{ mA to } +5.0\mbox{ mA} \\ \end{array}$

Voltage Applied to Any Output

in the Disabled or

Power-Off State -0.5V to +5.5V in the HIGH State -0.5V to V_{CC}

Current Applied to Output

in LOW State (Max) Twice the rated I_{OL} (mA)

DC Latchup Source Current -500 mA
Over Voltage Latchup (I/O) 10V

Recommended Operating Conditions

Free Air Ambient Temperature -40°C to $+85^{\circ}\text{C}$ Supply Voltage +4.5V to +5.5V

Minimum Input Edge Rate ($\Delta V/\Delta t$)

Data Input 50 mV/ns
Enable Input 20 mV/ns

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

| Symbol | Parameter | Min | Тур | Max | Units | v _{cc} | Conditions |
|------------------|--|------|-----|------|-------|-----------------|--|
| V _{IH} | Input HIGH Voltage | 2.0 | | | V | | Recognized HIGH Signal |
| V _{IL} | Input LOW Voltage | | | 0.8 | V | | Recognized LOW Signal |
| V _{CD} | Input Clamp Diode Voltage | | | -1.2 | V | Min | I _{IN} = -18 mA |
| V _{OH} | Output HIGH Voltage | 2.5 | | | V | Min | $I_{OH} = -3 \text{ mA}$ |
| | | 2.0 | | | • | IVIIII | $I_{OH} = -32 \text{ mA}$ |
| V _{OL} | Output LOW Voltage | | | 0.55 | V | Min | I _{OL} = 64 mA |
| I _{IH} | Input HIGH Current | | | 1 | μА | Max | V _{IN} = 2.7V (Note 4) |
| | | | | 1 | μΛ | IVIAX | $V_{IN} = V_{CC}$ |
| I _{BVI} | Input HIGH Current | | | 7 | μА | Max | V _{IN} = 7.0V |
| | Breakdown Test | | | • | μιτ | IVICA | VIN - 7.5 V |
| I _{IL} | Input LOW Current | | | -1 | μА | Max | V _{IN} = 0.5V (Note 4) |
| | | | | -1 | | max | $V_{IN} = 0.0V$ |
| V_{ID} | Input Leakage Test | 4.75 | | | V | 0.0 | $I_{ID} = 1.9 \mu A$ |
| | | | | | | | All Other Pins Grounded |
| I_{OZH} | Output Leakage Current | | | 10 | μΑ | 0 – 5.5V | $V_{OUT} = 2.7V; \overline{OE} = 2.0V$ |
| I _{OZL} | Output Leakage Current | | | -10 | μΑ | 0 – 5.5V | V _{OUT} = 0.5V; OE = 2.0V |
| los | Output Short-Circuit Current | -100 | | -275 | mA | Max | V _{OUT} = 0.0V |
| I _{CEX} | Output HIGH Leakage Current | | | 50 | μΑ | Max | V _{OUT} = V _{CC} |
| I _{ZZ} | Bus Drainage Test | | | 100 | μΑ | 0.0 | V _{OUT} = 5.5V; All Others GND |
| I _{CCH} | Power Supply Current | | | 50 | μΑ | Max | All Outputs HIGH |
| I _{CCL} | Power Supply Current | | | 30 | mA | Max | All Outputs LOW |
| I _{CCZ} | Power Supply Current | | | 50 | μΑ | Max | OE = V _{CC} |
| | | | | | | | All Others at V _{CC} or GND |
| I _{CCT} | Additional I _{CC} /Input Outputs Enable | d | | 2.5 | mA | | $V_I = V_{CC} - 2.1V$ |
| | Outputs 3-STAT | E | | 2.5 | mA | Max | Enable Input V _I = V _{CC} - 2.1V |
| | Outputs 3-STAT | E | | 2.5 | mA | | Data Input V _I = V _{CC} - 2.1V |
| | | | | | | | All Others at V _{CC} or GND |
| I _{CCD} | Dynamic I _{CC} No Load | | | | mA/ | Max | Outputs Open |
| | (Note 4) | | | 0.12 | MHz | | OE = GND, LE = V _{CC} (Note 3) |
| | | | | | | | One Bit Toggling, 50% Duty Cycle |

Note 3: For 8 bits toggling, I_{CCD} < 0.8 mA/MHz.

Note 4: Guaranteed but not tested.

DC Electrical Characteristics

| Symbol | Parameter | Min | Тур | Max | Units | v _{cc} | Conditions $C_1 = 50 \text{ pF, } R_1 = 500\Omega$ |
|------------------|--|------|------|-----|-------|-----------------|--|
| V _{OLP} | Quiet Output Maximum Dynamic V _{OL} | | 0.7 | 1.0 | V | 5.0 | T _A = 25°C (Note 5) |
| V _{OLV} | Quiet Output Minimum Dynamic V _{OL} | -1.5 | -1.2 | | V | 5.0 | T _A = 25°C (Note 5) |
| V _{OHV} | Minimum HIGH Level Dynamic Output Voltage | 2.5 | 3.0 | | V | 5.0 | T _A = 25°C (Note 6) |
| V _{IHD} | Minimum HIGH Level Dynamic Input Voltage | 2.2 | 1.8 | | V | 5.0 | T _A = 25°C (Note 7) |
| V _{ILD} | Maximum LOW Level Dynamic Input Voltage | | 1.0 | 0.7 | V | 5.0 | T _A = 25°C (Note 7) |

Note 5: Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output at LOW. Guaranteed, but not tested.

Note 6: Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

Note 7: Max number of expects defined as (i), in Tradampted and interest is 50. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{IHD}). Guaranteed, but not tested.

AC Electrical Characteristics

(SOIC and SSOP Package)

| Symbol | Parameter | | $T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$ | | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$ | | Units | |
|------------------|----------------------------------|-----|---|-----|--|-----|-------|--|
| | | Min | Тур | Max | Min | Max | | |
| t _{PLH} | Propagation Delay | 1.9 | 2.7 | 4.5 | 1.9 | 4.5 | 20 | |
| t _{PHL} | D _n to O _n | 1.9 | 2.8 | 4.5 | 1.9 | 4.5 | ns | |
| t _{PLH} | Propagation Delay | 2.0 | 3.1 | 5.0 | 2.0 | 5.0 | ns | |
| t _{PHL} | LE to O _n | 2.0 | 3.0 | 5.0 | 2.0 | 5.0 | 115 | |
| t _{PZH} | Output Enable Time | 1.5 | 3.1 | 5.3 | 1.5 | 5.3 | ns | |
| t _{PZL} | | 1.5 | 3.1 | 5.3 | 1.5 | 5.3 | IIS | |
| t _{PHZ} | Output Disable Time | 2.0 | 3.6 | 5.4 | 2.0 | 5.4 | ns | |
| t _{PLZ} | Time | 2.0 | 3.4 | 5.4 | 2.0 | 5.4 | 115 | |

AC Operating Requirements

(SOIC and SSOP Package)

| Symbol | Symbol Parameter | | $T_A = +25$ °C $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$ | | | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$ | |
|---------------------|-----------------------------|-----|---|-----|-----|--|-----|
| | | Min | Тур | Max | Min | Max | |
| f _{TOGGLE} | Max Toggle Frequency | | 100 | | | | MHz |
| t _S (H) | Set Time, HIGH | 1.5 | | | 1.5 | | 20 |
| t _S (L) | or LOW D _n to LE | 1.5 | | | 1.5 | | ns |
| t _H (H) | Hold Time, HIGH | 1.0 | | | 1.0 | | 20 |
| t _H (L) | or LOW D _n to LE | 1.0 | | | 1.0 | | ns |
| t _W (H) | Pulse Width, LE HIGH | 3.0 | | | 3.0 | | ns |

Extended AC Electrical Characteristics

(SOIC Package)

| Symbol | Parameter | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V to } 5.5\text{V}$ $C_L = 50 \text{ pF}$ 8 Outputs Switching (Note 8) | | $T_A = -40$ °C to +85°C $V_{CC} = 4.5$ V to 5.5V $C_L = 250$ pF (Note 9) | | $T_A = -40$ °C to +85 °C $V_{CC} = 4.5$ V to 5.5V $C_L = 250$ pF 8 Outputs Switching (Note 10) | | Units |
|------------------|----------------------------------|---|-----|---|-----|--|------|-------|
| | | Min | Max | Min | Max | Min | Max | |
| t _{PLH} | Propagation Delay | 1.5 | 5.2 | 2.0 | 6.8 | 2.0 | 9.0 | |
| t _{PHL} | D _n to O _n | 1.5 | 5.2 | 2.0 | 6.8 | 2.0 | 9.0 | ns |
| t _{PLH} | Propagation Delay | 1.5 | 5.5 | 2.0 | 7.5 | 2.0 | 9.5 | 20 |
| t _{PHL} | LE to O _n | 1.5 | 5.5 | 2.0 | 7.5 | 2.0 | 9.5 | ns |
| t _{PZH} | Output Enable Time | 1.5 | 6.2 | 2.0 | 8.0 | 2.0 | 10.5 | 20 |
| t_{PZL} | | 1.5 | 6.2 | 2.0 | 8.0 | 2.0 | 10.5 | ns |
| t _{PHZ} | Output Disable Time | 1.0 | 5.5 | (Note 11) | | (Note 11) (Note 11) | | ne |
| t_{PLZ} | | 1.0 | 5.5 | | | | | ns |

Note 8: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).

Note 9: This specification is guaranteed but not tested. The limits represent propagation delay with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Note 10: This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 11: The 3-STATE delay times are dominated by the RC network $(500\Omega, 250 \text{ pF})$ on the output and has been excluded from the datasheet.

Skew

(Note 12)

(SOIC Package)

| Symbol | Parameter | $T_A = -40$ °C to +85 °C $V_{CC} = 4.5$ V to 5.5V $C_L = 50$ pF 8 Outputs Switching (Note 12) | $T_A = -40$ °C to +85 °C $V_{CC} = 4.5$ V to 5.5V $C_L = 250$ pF 8 Outputs Switching (Note 13) | Units |
|-----------------------------|---|---|--|-------|
| t _{OSHL} (Note 14) | Pin to Pin Skew, HL Transitions | 1.0 | 1.5 | ns |
| t _{OSLH} (Note 14) | Pin to Pin Skew, LH Transitions | 1.0 | 1.5 | ns |
| t _{PS} (Note 15) | Duty Cycle, LH-HL Skew | 1.4 | 3.5 | ns |
| t _{OST} (Note 14) | Pin to Pin Skew, LH/HL Transitions | 1.5 | 3.9 | ns |
| t _{PV} (Note 16) | Device to Device Skew LH/HL Transitions | 2.0 | 4.0 | ns |

Note 12: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.)

Note 13: This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load.

Note 14: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW (t_{OSHL}), LOW-to-HIGH (t_{OSLH}), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW (t_{OST}). This specification is guaranteed but not tested.

Note 15: This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested.

Note 16: Propagation delay variation for a given set of conditions (i.e., temperature and V_{CC}) from device to device. This specification is guaranteed but not tested

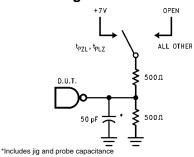
Capacitance

| Symbol | Parameter | Тур | Units | Conditions (T _A = 25°C) |
|----------------------------|--------------------|-----|-------|---------------------------------------|
| C _{IN} | Input Capacitance | 5 | pF | $V_{CC} = 0V$ |
| C _{OUT} (Note 17) | Output Capacitance | 9 | pF | V _{CC} = 5.0V |

Note 17: C_{OUT} is measured at frequency f = 1 MHz per MIL-STD-883B, Method 3012.

Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

AC Loading



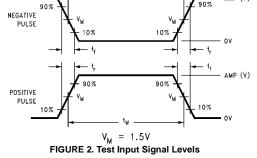


FIGURE 1. Test Load

| Amplitude | Rep. Rate | t _W | t _r | t _f |
|-----------|-----------|----------------|----------------|----------------|
| 3.0V | 1 MHz | 500 ns | 2.5 ns | 2.5 ns |

FIGURE 3. Test Input Signal Requirements

AC Waveforms

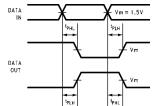


FIGURE 4. Propagation Delay Waveforms for **Inverting and Non-Inverting Functions**

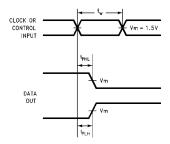


FIGURE 5. Propagation Delay, **Pulse Width Waveforms**

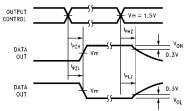


FIGURE 6. 3-STATE Output HIGH and LOW Enable and Disable Times

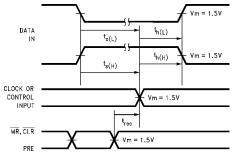
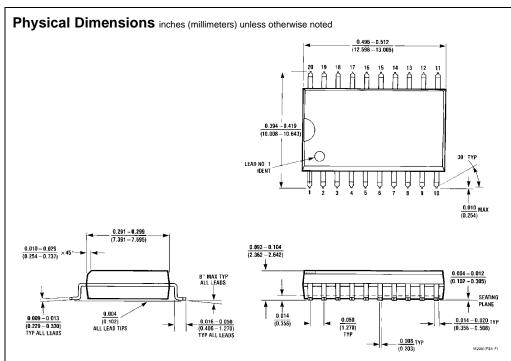
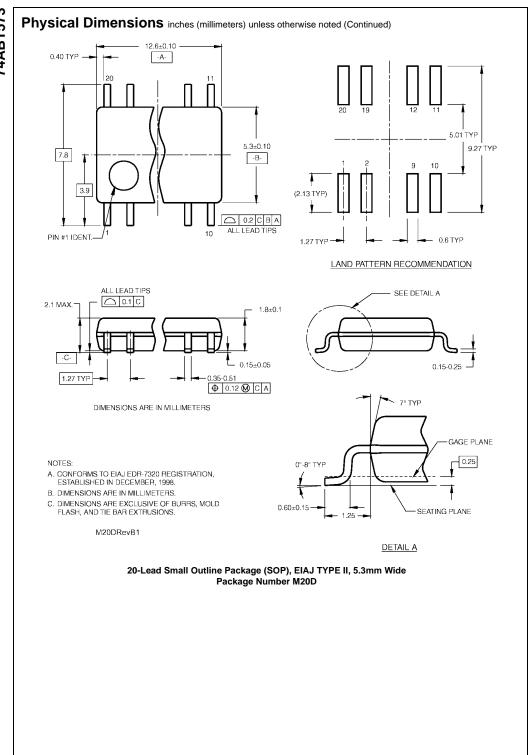
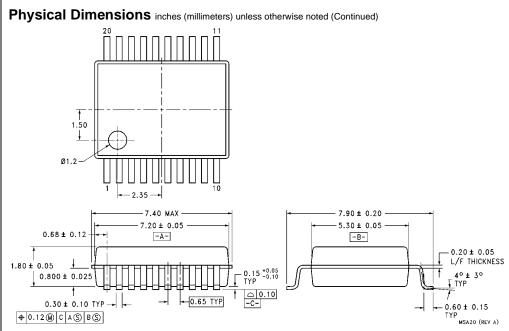


FIGURE 7. Setup Time, Hold Time and Recovery Time Waveforms

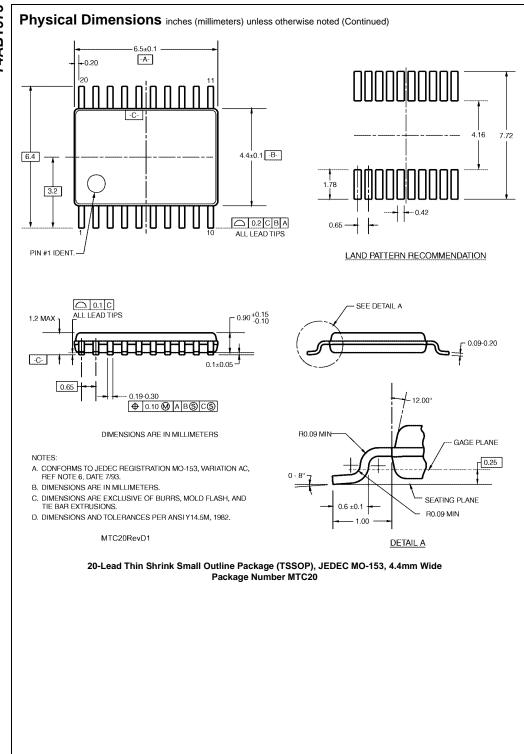


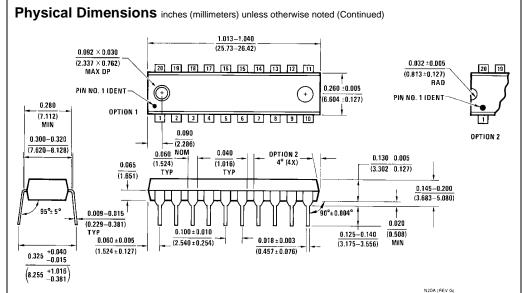
20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body Package Number M20B





20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide Package Number MSA20





20-Lead Plastic Dual-In-Line (PDIP), JEDEC MS-01, 0.300" Wide Package Number N20A

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